ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pan	PC. Bannockł	ourn, Illinois, A	Il rights reserved untions.	under both	This docum level parts, t	ent is a declarati the declaration e	on of the su	ibstances v s all lower	within the manufactu level materials for v	urer listed which the	item. Note: manufacture	if the item is an as er has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and I					Afg Informa	tion			
Supplier Information														
Company name* Comp			ompany unique ID			Unique ID Authority				Respon	Response Date*			
onsemi										2023-0	2023-06-08			
Title - Contact			et		Phone - Contact*					Email - Contact*				
Product-Env-Stewards Product Envir			nviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Represent			esentative			Phone - Representative*			Email	Email - Representative*				
Product-Env-Stewards Product En			luct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	n Number	Mfr Item Name			Effective Date	Version	ion Manufacturing Site			Weight*	UOM	Unit Type	
	NCP111	NCP1117ST33T3G ANA SOT223		800MA LDO		2023-06-08		M	MY1		108.5	mg	Each	
Aanufacturing Proccess Informat	tion		•											
Terminal Plating / Grid Array Ma	terial 7	Ferminal Base A	Alloy J-STD-020 MSL Rat		L Rating	Peak Proce	Peak Process Body Temperati		ure Max Time at Peak Tempe		ature Num	ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alle		CU Alloy	1			260	260 C		30 seco		seconds 3			
omments														
vel 1 - maximum time at peak temperatu	re during so	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.1	mg	Supplier	Silicon (Si)	7440-21-3		1.1	mg
Die Attach	0.75	mg		Epoxy resin	proprietary data		0.0188	mg
			Supplier	Silver (Ag)	7440-22-4		0.6338	mg
			Supplier	Phenolic Resin	Proprietary Data		0.0188	mg
			Supplier	Inorganic filler	Proprietary Data		0.0188	mg
			Supplier	Dicyandiamine	461-58-5		0.0037	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0562	mg
Lead Frame	37.17	mg	Supplier	Silver (Ag)	7440-22-4		0.4832	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0372	mg
			Supplier	Iron (Fe)	7439-89-6		0.8921	mg
			Supplier	Copper (Cu)	7440-50-8		35.7575	mg
Mold Compound-Black	61.9	mg		Epoxy resin	proprietary data		3.095	mg
			Supplier	Phenolic Resin	Proprietary Data		3.095	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		1.238	mg
			Supplier	Carbon Black (C)	1333-86-4		0.3095	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		54.1625	mg
Plating	7.44	mg	Supplier	Tin (Sn)	7440-31-5		7.44	mg
Wire Bond - Cu	0.14	mg	Supplier	Copper (Cu)	7440-50-8		0.14	mg